

BOOTH APPLICATION FORM

Application Deadline: MAY 10, 2024

To be waitlisted, please fill in this form and email to the secretariat: tokyopack@jpi.or.jp

Applications will be accepted on first come first served basis subject to availability.

APPLICATION PROCESS

1. Please fill out the application form below or on the official website.
2. E-mail the copy to: tokyopack@jpi.or.jp by May 10, 2024.
3. The invoice will be sent from TOKYOPACK 2024 Secretariat within 10 days after receiving the application form.

*Application is considered as accepted once the participation fee is paid.

COMPANY INFORMATION:

Company/Organization Name: _____

Address: _____

Country: _____

Tel : _____ Website: _____

Contact person: Mr./Ms. _____ Title: _____

Contact E-mail: _____

Agent or representative in Japan, if you have one : _____

Address: _____

Contact Person: _____ Position: _____

Tel : _____ Fax: _____ E-mail: _____

BOOTHS:

We wish to purchase _____ booth(s). (1 booth =2.97m X2.97m)

Basic Booth @ ¥ 385,000(JPY) × _____ Booth(s) = ¥ _____ (JPY)

¥ 374,000 before Dec.15, 2023 (Early Bird) *10%Consumption Tax included

Please circle the preferred space layout if you purchase 4 booths or more.

- | | | |
|-----------------|-----------------|-----------------|
| 1. Single line | 2. Double line | 3. Block Type 3 |
| 4. Block Type 4 | 5. Block Type 5 | |

Early Bird Special: A discount of 11,000 yen per booth when you submit your applications before Dec. 15, 2023.

*Bulk purchase special: 10,000 yen /per booth will be deducted for the purchase of more than 20 booths.
: 20,000 yen /per booth will be deducted for the purchase of more than 30 booths.

EXHIBITS:

Product category (Please check all applicable exhibiting products):

- 1 . Packaging Materials / Containers
- 2 . Packaging Machines
- 3 . Printing / Converting Machines

- 4 . Food / Pharmaceutical / Clean and Sterile Processing Machinery
- 5 . Inspection / Measurement / environment-related Equipment
- 6 . Packaging Design / Communication / Service
- 7 . Packaging & Logistics Solutions
- 8 . Next Generation Technologies
- 9 . PR • PRESS

Please fill in the details of the products to be displayed in TOKYOPACK2024

I / We, the undersigned, hereby apply for exhibition space in TOKYO PACK 2024 as indicated above under the terms and regulations described in the Application Outline and Terms of Exhibition.

Signature:

Date:

For more information and contact:
TOKYO PACK 2024 Secretariat c/o Japan Packaging Institute
Email: tokyopack@jpi.or.jp
Tel: +81-3-3543-1189